

STFU23N80K5

N-channel 800 V, 0.23 Ω typ., 16 A MDmesh™ K5 Power MOSFET in a TO-220FP ultra narrow leads package

Datasheet - production data

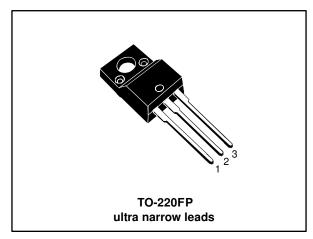
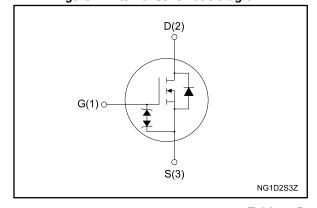


Figure 1: Internal schematic diagram



Features

Order code	V _{DS}	R _{DS(on)} max.	lο	Ртот
STFU23N80K5	800 V	0.28 Ω	16 A	35 W

- Industry's lowest R_{DS(on)} x area
- Industry's best FoM (figure of merit)
- Ultra-low gate charge
- 100% avalanche tested
- Zener-protected

Applications

• Switching applications

Description

This very high voltage N-channel Power MOSFET is designed using MDmesh™ K5 technology based on an innovative proprietary vertical structure. The result is a dramatic reduction in on-resistance and ultra-low gate charge for applications requiring superior power density and high efficiency.

Table 1: Device summary

Order code	Marking	Package	Packing
STFU23N80K5	23N80K5	TO-220FP ultra narrow leads	Tube

Contents STFU23N80K5

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STFU23N80K5 Electrical ratings

1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _G s	Gate-source voltage	±30	V
ID	Drain current (continuous) at T _{case} = 25 °C	16	Α
ID	Drain current (continuous) at T _{case} = 100 °C		А
I _{DM} ⁽¹⁾	Drain current (pulsed)	64	Α
P _{TOT}	Total dissipation at T _{case} = 25 °C	35	W
dv/dt ⁽²⁾	Peak diode recovery voltage slope	4.5	V/ns
dv/dt ⁽³⁾	MOSFET dv/dt ruggedness	50	V/NS
V _{ISO}	Insulation withstand voltage (RMS) from all three leads to external heat sink (t= 1 s, T_{C} = 25 °C)	2500	V
T _{stg}	Storage temperature range	-55 to 150	°C
T_{j}			C

Notes:

Table 3: Thermal data

Symbol	bol Parameter		Unit
R _{thj-case}	Thermal resistance junction-case	3.6	°C/W
R _{thj-amb}	Thermal resistance junction-ambient		-C/VV

Table 4: Avalanche characteristics

Symbol	Parameter		Unit
I _{AR} ⁽¹⁾	Avalanche current, repetitive or not repetitive	5	Α
E _{AS} ⁽²⁾	Single pulse avalanche energy	400	mJ

Notes:

 $[\]ensuremath{^{(1)}}\mbox{Pulse}$ width is limited by safe operating area.

 $^{^{(2)}}I_{SD} \leq$ 16 A, di/dt=100 A/ μs , VDs peak < V(BR)DSS, VDD = 80% V(BR)DSS

 $^{^{(3)}}V_{DS} \le 640 \text{ V}$

 $[\]ensuremath{^{(1)}}\mbox{Pulse}$ width limited by $T_{jmax}.$

 $^{^{(2)}}Starting~T_{j}=25~^{\circ}C,~I_{D}=I_{AR},~V_{DD}=50~V.$

Electrical characteristics STFU23N80K5

2 Electrical characteristics

(T_{case} = 25 °C unless otherwise specified)

Table 5: Static

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$	800			٧
	Zara gata valtaga drain	$V_{GS} = 0 \text{ V}, V_{DS} = 800 \text{ V}$			1	
IDSS	Zero gate voltage drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 800 \text{ V},$ $T_{case} = 125 \text{ °C}^{(1)}$			50	μΑ
I _{GSS}	Gate-body leakage current	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			±10	μΑ
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 100 \mu A$	3	4	5	V
R _{DS(on)}	Static drain-source on-resistance	V _{GS} = 10 V, I _D = 8 A		0.23	0.28	Ω

Notes:

Table 6: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		ı	1000	ı	
Coss	Output capacitance	V _{DS} = 100 V, f = 1 MHz, V _{GS} = 0 V	1	65	1	pF
Crss	Reverse transfer capacitance	• do = 0 •	-	1.5	-	
$C_{O(tr)}^{(1)}$	Equivalent output capacitance	$V_{DS} = 0$ to 640 V, $V_{GS} = 0$ V	-	165	-	~F
C _{O(er)} (2)	Equivalent output capacitance	$V_{DS} = 0$ to 640 V, $V_{GS} = 0$ V	1	59	1	pF
R_{G}	Intrinsic gate resistance	$f = 1 \text{ MHz}, I_D = 0 \text{ A}$	-	4.7	-	Ω
Qg	Total gate charge	$V_{DD} = 640 \text{ V}, I_D = 16 \text{ A},$	1	33	1	
Qgs	Gate-source charge	V _{GS} = 0 to 10 V (see Figure 14: "Test circuit	-	6	-	nC
Q_{gd}	Gate-drain charge	for gate charge behavior")	-	25	-	

Notes

 $^{(1)}$ Time related is defined as a constant equivalent capacitance giving the same charging time as Coss when V_{DS} increases from 0 to 80% V_{DSS}.

⁽¹⁾Defined by design, not subject to production test.

 $^{^{(2)}}$ Energy related is defined as a constant equivalent capacitance giving the same stored energy as Coss when V_{DS} increases from 0 to 80% V_{DSS}.

Table 7: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	$V_{DD} = 400 \text{ V}, I_D = 8 \text{ A}$	ı	14	1	
tr	Rise time	$R_G = 4.7 \Omega$, $V_{GS} = 10 V$ (see Figure 13: "Test circuit for		9	1	
t _{d(off)}	Turn-off delay time	resistive load switching times"	-	48	-	ns
t _f	Fall time	and Figure 18: "Switching time waveform")	-	9	-	

Table 8: Source-drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		1		16	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		ı		64	Α
V _{SD} ⁽²⁾	Forward on voltage	$V_{GS} = 0 \text{ V}, I_{SD} = 16 \text{ A}$	1		1.5	V
t _{rr}	Reverse recovery time	$I_{SD} = 16 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	410		ns
Qrr	Reverse recovery charge	V _{DD} = 60 V (see Figure 15: "Test circuit for	1	7		μC
I _{RRM}	Reverse recovery current	inductive load switching and diode recovery times")	ı	34		Α
t _{rr}	Reverse recovery time	$I_{SD} = 16 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	650		ns
Qrr	Reverse recovery charge	$V_{DD} = 60 \text{ V}, T_j = 150 ^{\circ}\text{C}$ (see Figure 15: "Test circuit for	-	10		μC
I _{RRM}	Reverse recovery current	inductive load switching and diode recovery times")	-	32		Α

Notes:

Table 9: Gate-source Zener diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)GSO}$	Gate-source breakdown voltage	$I_{GS} = \pm 1 \text{ mA}, I_D = 0 \text{ A}$	±30	-	-	V

The built-in back-to-back Zener diodes are specifically designed to enhance the ESD performance of the device. The Zener voltage facilitates efficient and cost-effective device integrity protection, thus eliminating the need for additional external componentry.



⁽¹⁾ Pulse width is limited by safe operating area.

 $^{^{(2)}}$ Pulse test: pulse duration = 300 μ s, duty cycle 1.5%.

2.1 Electrical characteristics (curves)

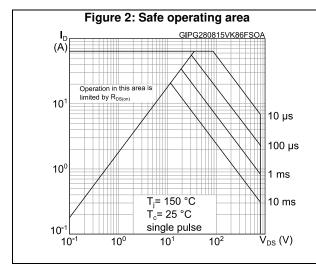
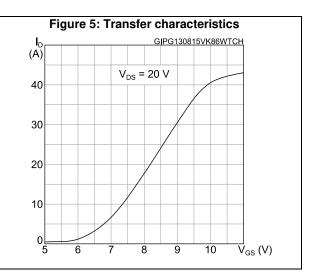
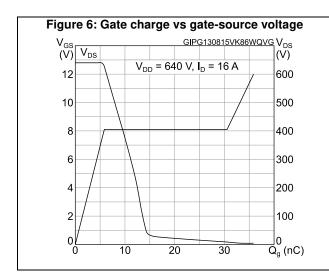
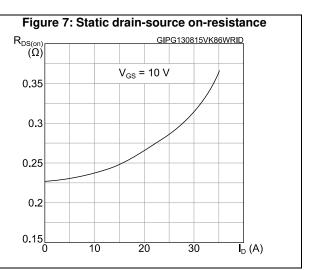


Figure 3: Thermal impedance 0.20521 0.1 0.05 0.005 0.002 0.01 0.01 0.01 0.02 0.01 0.02 0.01 0.02 0.01 0.02 0.01 0.02 0.01 0.02 0.01 0.02 0.02 0.01 0.02 0.01 0.02 0.02 0.01 0.02 0.02 0.01 0.02 0.02 0.03 0.02 0.01 0.02 0.03 0.04 0.05

Figure 4: Output characteristics GIPG130815VK86WOCH **I**_D (Α) 40 V_{GS}= 11 V V_{GS}= 10 V 30 V_{GS} = 9 V 20 V_{GS}= 8 V 10 V_{GS} = 7 V V_{GS} = 6 V0 $\vec{V}_{DS}(V)$ 12 16







STFU23N80K5 Electrical characteristics

Figure 8: Capacitance variations C (pF) GIPG130815VK86WCVR 10^{3} C_{ISS} 10² C_{OSS} f = 1 MHz10¹ C_{RSS} 10⁰ $\overline{V}_{DS}(V)$ 10⁻¹ 10⁰ 10¹ 10²

Figure 9: Normalized gate threshold voltage vs temperature

V_{GS(th)}
(norm.)

1.2

1.0

0.8

0.6

0.4

0.2

-50

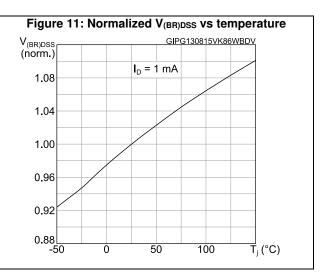
0

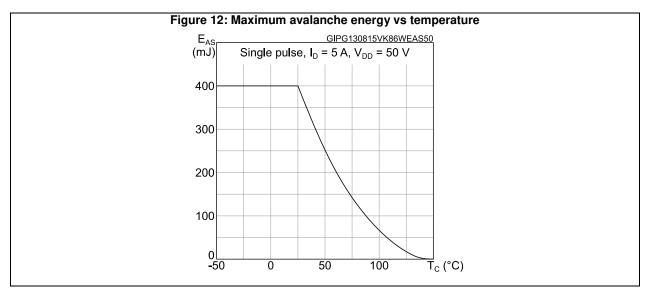
50

100

T_j(°C)

Figure 10: Normalized on-resistance vs temperature $R_{DS(on)}$ (norm.) 2.6 $V_{GS} = 10 \text{ V}$ 2.2 1.8 1.4 1.0 0.6 0.2 0.5 0 0.5 0 0.5 0 0.5 0 0.5 0 0.5 0 0.5 0 0.5 0 0.5 0 0.5 0 0.5 0 0.5 0 0.5 0 0.5 0 0.5 0 0.5 0 0.5 0 0.5 0 0 0.5 0 0.5 0 0.5 0 0.5 0 0.5 0 0.5 0 0 0.5 0 0.5 0 0.5 0 0.5 0 0.5 0 0.5 0 0 0.5 0 0.5 0 0.5 0 0.5 0 0.5 0 0.5 0 0 0.5 0 0.5 0 0.5 0 0.5 0 0.5 0 0.5 0 0 0.5 0 0.5 0 0.5 0 0.5 0 0.5 0 0.5 0 0 0.5 0 0.5 0 0.5 0 0.5 0 0.5 0 0.5 0 0.5 0 0.5 0 0.5 0 0.5 0 0.5 0 0.5 0 0.5 0 0.5 0 0.5 0 0.5 0 0.5 0 0.5 0 0.5 0 0 0.5 0 0.5 0 0.5 0 0.5 0 0.5 0 0.5 0 0 0.5 0 0.5 0 0.5 0 0.5 0 0.5 0 0.5 0 0 0.5 0 0.5 0 0.5 0 0.5 0 0.5 0 0.5 0 0 0.5 0 0.5 0 0.5 0 0.5 0 0.5 0.5 0.5 0 0.5





Test circuits STFU23N80K5

3 Test circuits

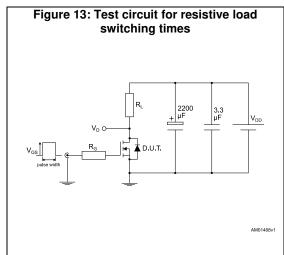


Figure 14: Test circuit for gate charge behavior

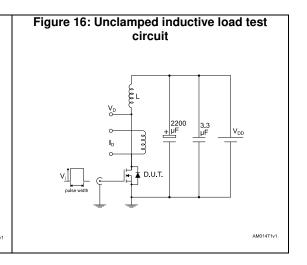
12 V 47 KΩ 100 Ω D.U.T.

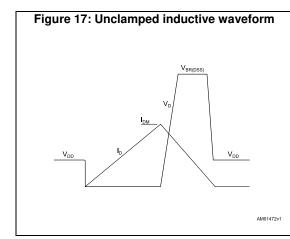
12 V 47 KΩ VG

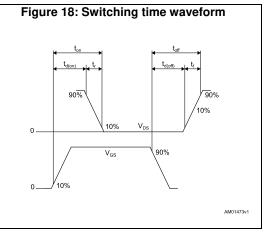
14 KΩ VG

AM01468v1

Figure 15: Test circuit for inductive load switching and diode recovery times







STFU23N80K5 Package information

4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

4.1 TO-220FP ultra narrow leads package information

В ω F1(x3) D G1 Ε 8576148_1

Figure 19: TO-220FP ultra narrow leads package outline

Table 10: TO-220FP ultra narrow leads mechanical data

Dim		mm	
Dim.	Min.	Тур.	Max.
Α	4.40		4.60
В	2.50		2.70
D	2.50		2.75
Е	0.45		0.60
F	0.65		0.75
F1	-		0.90
G	4.95		5.20
G1	2.40	2.54	2.70
Н	10.00		10.40
L2	15.10		15.90
L3	28.50		30.50
L4	10.20		11.00
L5	2.50		3.10
L6	15.60		16.40
L7	9.00		9.30
L8	3.20		3.60
L9	-		1.30
Dia.	3.00		3.20

STFU23N80K5 Revision history

5 Revision history

Table 11: Document revision history

Date	Revision	Changes
21-Feb-2017	1	First release

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